TOIREX

XP131A1617SR

ETR1105_001

Power MOSFET

■ GENERAL DESCRIPTION

The XP131A1617SR is an N-channel Power MOSFET with low on-state resistance and ultra high-speed switching characteristics.

Because high-speed switching is possible, the IC can be efficiently set thereby saving energy $\frac{1}{2}$

The small SOP-8 package makes high density mounting possible.

■APPLICATIONS

- Notebook PCs
- Cellular and portable phones
- On-board power supplies
- Li-ion battery systems

■FEATURES

Low On-State Resistance: Rds(on)= 0.014Ω (Vgs=4.5V)

: Rds(on)=0.019 Ω (Vgs=2.5V)

Ultra High-Speed Switching

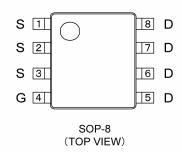
Driving Voltage : 2.5V

N-Channel Power MOSFET

DMOS Structure

Package : SOP-8

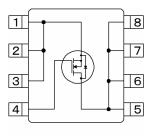
■PIN CONFIGURATION



■PIN ASSIGNMENT

| PIN NUMBER | PIN NAME | FUNCTION |
|------------|----------|----------|
| 1~3 | S | Source |
| 4 | G | Gate |
| 5~8 | D | Drain |

■EQUIVALENT CIRCUIT



N-channel MOSFET (1 device built-in)

■ABSOLUTE MAXIMUM RATINGS

Ta = 25°C

| PARAMETER | SYMBOL | RATINGS | UNITS |
|-----------------------------|--------|---------|-------|
| Drain-Source Voltage | Vdss | 20 | ٧ |
| Gate-Source Voltage | Vgss | ±12 | ٧ |
| Drain Current (DC) | ld | 10 | Α |
| Drain Current (Pulse) | ldp | 40 | Α |
| Reverse Drain Current | ldr | 10 | Α |
| Channel Power Dissipation * | Pd | 2.5 | W |
| Channel Temperature | Tch | 150 | °C |
| Storage Temperature Range | Tstg | -55~150 | °C |

^{*} When implemented on a glass epoxy PCB

■ELECTRICAL CHARACTERISTICS

DC Characteristics Ta = 25°C

| PARAMETER | SYMBOL | CONDITIONS | MIN. | TYP. | MAX. | UNITS |
|-------------------------------------|----------|------------------|------|-------|-------|-------|
| Drain Cut-Off Current | ldss | Vds=20V, Vgs=0V | - | - | 10 | μΑ |
| Gate-Source Leak Current | Igss | Vgs=±12V, Vds=0V | - | - | ±1 | μΑ |
| Gate-Source Cut-Off Voltage | Vgs(off) | Id=1mA, Vds=10V | 0.7 | - | 1.4 | V |
| Drain-Source On-State Resistance * | Rds(on) | Id=5A, Vgs=4.5V | - | 0.010 | 0.014 | Ω |
| | | Id=5A, Vgs=2.5V | - | 0.013 | 0.019 | Ω |
| Forward Transfer Admittance * | Yfs | Id=5A, Vds=10V | - | 32 | - | S |
| Body Drain Diode Forward Voltage | Vf | If=10A, Vgs=0V | - | 0.8 | 1.1 | V |

^{*} Effective during pulse test.

Dynamic Characteristics

Ta = 25°C

| PARAMETER | SYMBOL | CONDITIONS | MIN. | TYP. | MAX. | UNITS |
|----------------------|--------|---------------------------|------|------|------|-------|
| Input Capacitance | Ciss | Vds=10V, Vgs=0V f=1MHz | - | 1650 | - | pF |
| Output Capacitance | Coss | | - | 1000 | - | pF |
| Feedback Capacitance | Crss | | - | 450 | - | pF |

Switching Characteristics

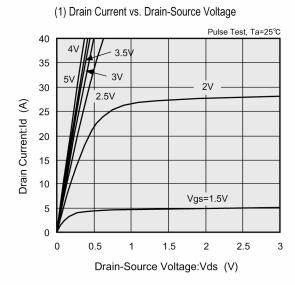
Ta = 25°C

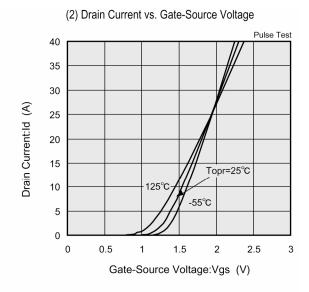
| PARAMETER | SYMBOL | CONDITIONS | MIN. | TYP. | MAX. | UNITS |
|---------------------|----------|--------------------------|------|------|------|-------|
| Turn-On Delay Time | td (on) | Vgs=5V, Id=5A Vdd=10V | - | 15 | - | ns |
| Rise Time | tr | | - | 25 | - | ns |
| Turn-Off Delay Time | td (off) | | - | 65 | - | ns |
| Fall Time | tf | | - | 15 | - | ns |

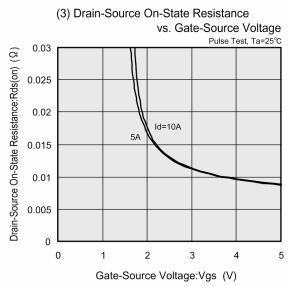
Thermal Characteristics

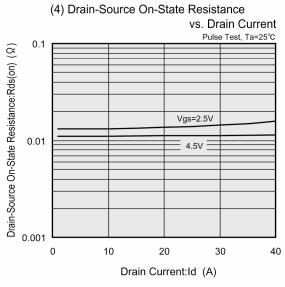
| PARAMETER | SYMBOL | CONDITIONS | MIN. | TYP. | MAX. | UNITS |
|---|------------|--------------------------------------|------|------|------|-------|
| Thermal Resistance (Channel-Aambience) | Rth (ch-a) | Implement on a glass epoxy resin PCB | ı | 50 | ı | °C/W |

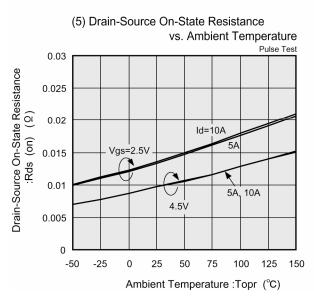
■TYPICAL PERFORMANCE CHARACTERISTICS

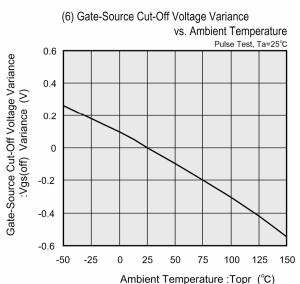




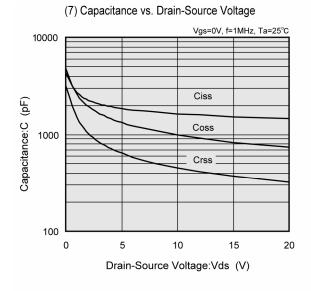


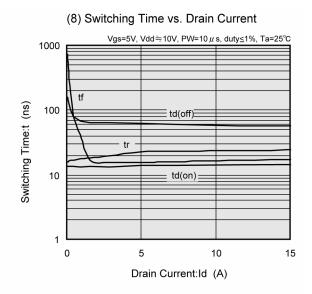


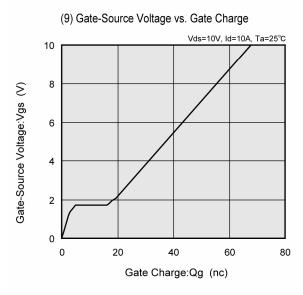


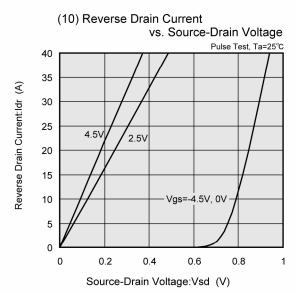


■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

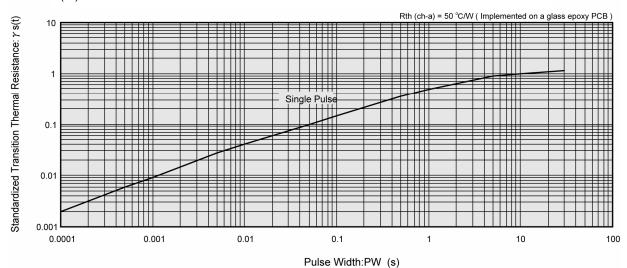












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